



Product Change Notification

Change Notification #: 118625-03
Change Title: Select Intel® Server System R2312WFTZSR, Intel® Server System R2308WFTZSR, Intel® Server System R2224WFTZSR, Intel® Server System R2208WF0ZSR, Intel® Server System R2208WFTZSR, Intel® Server System R1208WFTYSR, 2U Rear Hot-swap Dual Drive Cage Upgrade Kit A2UREARHSDK2, 2U Hot-swap 8x2.5inch SAS/NVMe Combo Drive Bay Kit A2U8X25S3PHS, PCN 118625-03, Product Design, Product Material
Alternate Hot Swap Backplane
Reason for Revision: Rectify TA Numbers

Date of Publication: January 13, 2022

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*	November 23, 2021
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Reason for Revision: Rectify TA Numbers

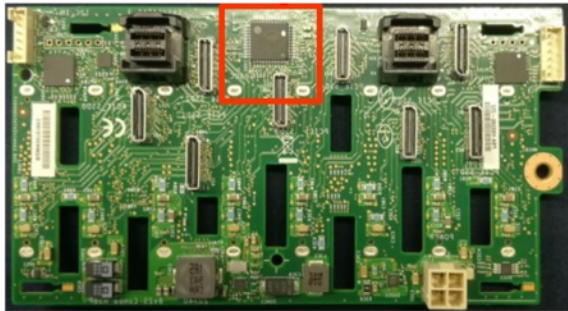
Intel is implementing the following changes to the item listed in table products affected below.

- Due to Integrated Circuit (IC) shortage from the supplier, a Programmable System-On-Chip (PSOC) used on the Hot Swap Backplanes needs to be replaced with an alternative component. The new component is identical in function than previous one but differs in form factor. For business continuity, demand fulfillment and to minimize customer impact, an interposer PCB supporting the new component was used. The new component has passed all functional and electrical validation test successfully.

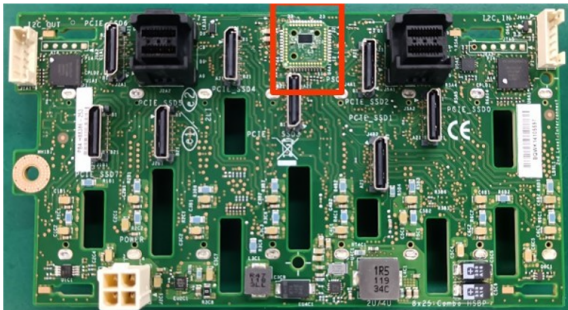
For such reason, products listed in the “Products Affected” table could be delivered to customers with any of two different PBA codes of hot swap backplanes which can be identified as:

MM# 986049: H88386-252 / H88386-253
MM# 986051: H88386-252 / H88386-253
MM# 986052: G97160-372 / G97160-373
MM# 986053: H88392-351 / H88392-352
MM# 986007: H88382-351 / H88382-352
MM# 955858: H88386-252 / H88386-253
MM# 986050: H88386-252 / H88386-253
MM# 958243: G94339-372 / G94339-373

PBA Code Before - H88386-252



PBA Code After - H88386-253



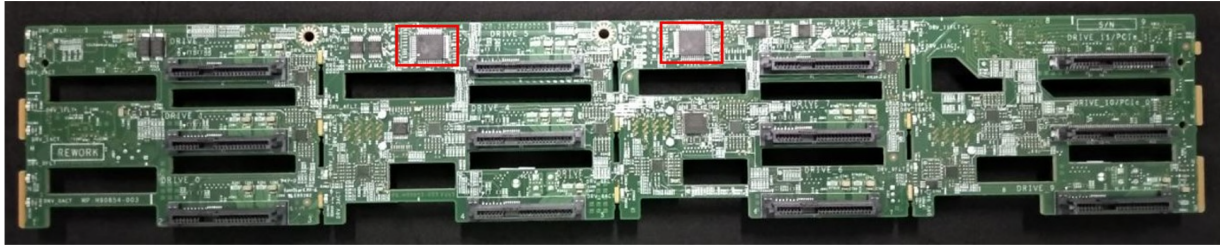
PBA Code Before - G97160-372



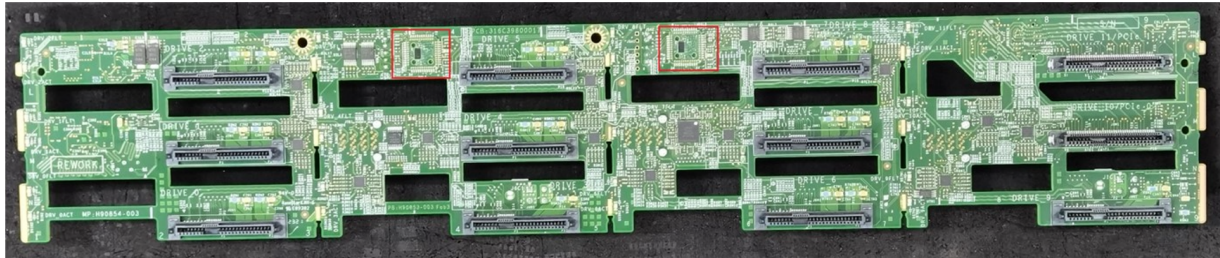
PBA Code After - G97160-373



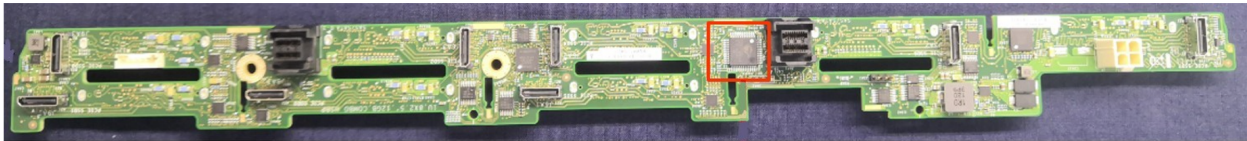
PBA Code Before - H88392-351



PBA Code After - H88392-352



PBA Code Before - H88382-351



PBA Code After - H88382-352



PBA Code Before - G94339-372



PBA Code After - G94339-373



Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA	Backplane PBA
2U Hot-swap 8x2.5inch SAS/NVMe Combo Drive Bay Kit A2U8X25S3PHS, Single	A2U8X25S3PHS	955858	J12659-005	J12659-006	H88386-252 H88386-253
2U Rear Hot-swap Dual Drive Cage Upgrade Kit A2UREARHSDK2, Single	A2UREARHSDK2	958243	J37326-002	J37326-003	G94339-372 G94339-373
Intel® Server System R1208WFTYSR, Single	R1208WFTYSR	986007	K39975-012	K39975-013	H88382-351 H88382-352
Intel® Server System R2208WFTZSR, Single	R2208WFTZSR	986049	K39991-011	K39991-012	H88386-252 H88386-253
Intel® Server System R2208WF0ZSR, Single	R2208WF0ZSR	986050	K39997-009	K39997-010	H88386-252 H88386-253
Intel® Server System R2224WFTZSR, Single	R2224WFTZSR	986051	K39998-009	K39998-010	H88386-252 H88386-253
Intel® Server System R2308WFTZSR, Single	R2308WFTZSR	986052	K40014-010	K40014-011	G97160-372 G97160-373
Intel® Server System R2312WFTZSR, Single	R2312WFTZSR	986053	K40015-012	K40015-013	H88392-351 H88392-352

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
October 26, 2021	00	Originally Published PCN
December 03, 2021	01	There was a typo on the PCN
December 13, 2021	02	Updating Change Description and Products Affected table
January 13, 2022	03	Rectify TA Numbers



Product Change Notification

118625-03

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

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